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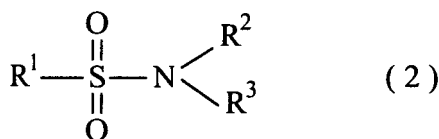
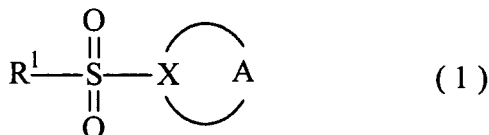
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(54) **ADHESION IMPROVER FOR PHOTSENSITIVE RESIN COMPOSITION AND
PHOTSENSITIVE RESIN COMPOSITION CONTAINING SAME**

(57) An adhesion-improving agent comprising a sulfonyl group substituted nitrogen compound represented by the below described general formulae (1) to (5) or a thiadiazole compound represented by the below described general formulae (6) to (8) and a photosensitive resin composition containing an alkali-soluble resin and a photosensitizer, comprising said adhesion-improving agent.



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